Photocouplers Photorelay

TLP3545A,TLP3545AF

1. Applications

- Mechanical relay replacements
- Heating, ventilation and air conditioning (HVAC)
- Security Systems
- Factory Automation (FA)
- Measuring Instruments

2. General

The TLP3545A and TLP3545AF photorelay consist of a photo MOSFET optically coupled to an infrared light emitting diode. It is housed in a 6-pin DIP package. The low ON-state resistance and the high permissible ON-state current of the TLP3545A and TLP3545AF make it suitable for power line control applications.

3. Features

- (1) Normally opened (1-Form-A)
- (2) OFF-state output terminal voltage: 60 V (min)
- (3) Trigger LED current: 3 mA (max)
- (4) ON-state current: 4 A (max) (A connection)
- (5) ON-state resistance: $60 \text{ m}\Omega$ (max) (A connection)
- (6) Isolation voltage: 2500 Vrms (min)
- (7) Safety standards

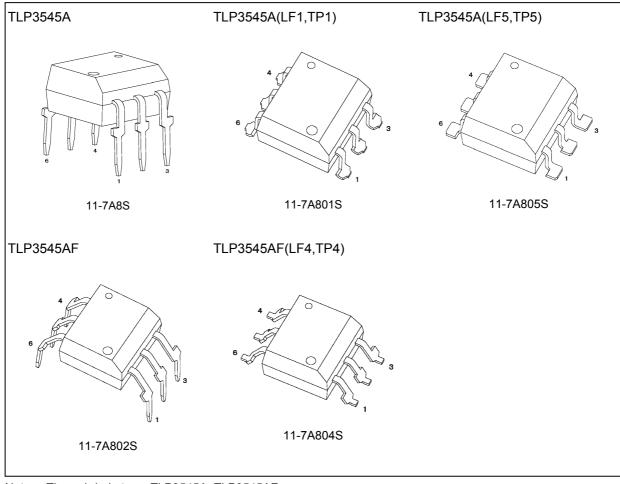
UL-approved: UL1577, File No.E67349

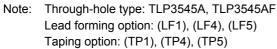
cUL-approved: CSA Component Acceptance Service No.5A File No.E67349

VDE-approved: EN60747-5-5 (Pending) (Note 1)

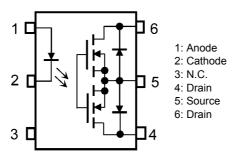
(Note 1): When a VDE approved type is needed, please designate the Option (D4).

4. Packaging (Note)

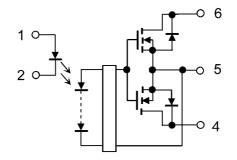




5. Pin Assignment



6. Internal Circuit



7. Absolute Maximum Ratings (Note) (Unless otherwise specified, T_a = 25 °C)

	Characteristics		Symbol	Note	Rating	Unit
LED	Input forward current		I _F		30	mA
	Input forward current derating	$(T_a \ge 25 \ ^\circ C)$	$\Delta I_F / \Delta T_a$		-0.3	mA/°C
	Input forward current (pulsed)	(100 μs pulse, 100 pps)	I _{FP}		1	A
	Input reverse voltage		V _R		6	V
	Input power dissipation		PD		50	mW
	Input power dissipation derating	$(T_a \ge 25 \ ^\circ C)$	$\Delta P_D / \Delta T_a$		-0.5	mW/°C
	Junction temperature		Tj		125	ů
Detector	OFF-state output terminal voltage		V _{OFF}		60	V
	ON-state current (A connection)		I _{ON}	(Note 1)	4	A
	ON-state current (B connection)				4	1
	ON-state current (C connection)				8	
	ON-state current derating (A connection)	(T _a ≥ 25 °C)	$\Delta I_{ON} / \Delta T_a$	(Note 1)	-40	mA/°C
	ON-state current derating (B connection)	$(T_a \ge 25 \ ^\circ C)$			-40	1
	ON-state current derating (C connection)	(T _a ≥ 25 °C)			-80]
	ON-state current (pulsed)	(t = 100 ms, duty = 1/10)	I _{ONP}		12	A
	Output power dissipation		Po		700	mW
	Output power dissipation derating	(T _a ≥ 25 °C)	$\Delta P_0 / \Delta T_a$		-7.0	mW/°C
	Junction temperature		Тj		125	°C
Common	Storage temperature		T _{stg}		-55 to 125	°C
	Operating temperature		T _{opr}		-40 to 110	°C
	Lead soldering temperature	(10 s)	T _{sol}		260	°C
	Isolation voltage	(AC, 60 s, R.H. ≤ 60 %)	BVS	(Note 2)	2500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: For an application circuit example, see Chapter 13.2.

Note 2: This device is considered as a two-terminal device: Pins 1, 2 and 3 are shorted together, and pins 4, 5 and 6 are shorted together.

8. Recommended Operating Conditions (Note)

Characteristics	Symbol	Note	Min	Тур.	Max	Unit
Supply voltage	V _{DD}		_	_	48	V
Input forward current	١ _F		5	10	25	mA
ON-state current (A connection)	I _{ON}		_	_	4	А
Operating temperature	T _{opr}		-40		85	°C

Note: The recommended operating conditions are given as a design guide necessary to obtain the intended performance of the device. Each parameter is an independent value. When creating a system design using this device, the electrical characteristics specified in this datasheet should also be considered.

9. Electrical Characteristics (Unless otherwise specified, $T_a = 25$ °C)

	Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
LED	Input forward voltage	V _F		I _F = 10 mA	1.50	1.64	1.80	V
	Input reverse current	I _R		V _R = 5 V	_	_	10	μA
	Input capacitance	Ct		V = 0 V, f = 1 MHz	_	70	_	pF
Detector	OFF-state current	I _{OFF}		V _{OFF} = 60 V	_	0.01	1	μA
	Output capacitance	C _{OFF}		V = 0 V, f = 1 MHz	_	640		pF

10. Coupled Electrical Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I _{FT}		I _{ON} = 1 A	_	0.3	3	mA
Return LED current	I _{FC}		I _{OFF} = 10 μA	0.01			mA
ON-state resistance (A connection)	R _{ON}	(Note 1)	I _{ON} = 3 A, I _F = 5 mA, t < 1 s	_	35	60	mΩ
ON-state resistance (B connection)			I _{ON} = 4 A, I _F = 5 mA, t < 1 s	_	18	—	
ON-state resistance (C connection)			I _{ON} = 8 A, I _F = 5 mA, t < 1 s		9		

Note 1: For an application circuit example, see Chapter 13.2.

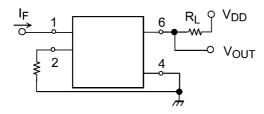
11. Isolation Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Total capacitance (input to output)	Cs	(Note 1)	V _S = 0 V, f = 1 MHz	—	0.8	—	pF
Isolation resistance	R _S	(Note 1)	V_S = 500 V, R.H. \leq 60 %	$5 imes 10^{10}$	10 ¹⁴	_	Ω
Isolation voltage	BVS	(Note 1)	AC, 60 s	2500	_	_	Vrms
			AC, 1 s in oil	—	5000	—	
			DC, 60 s, in oil	_	5000	_	Vdc

Note 1: This device is considered as a two-terminal device: Pins 1, 2 and 3 are shorted together, and pins 4, 5 and 6 are shorted together.

12. Switching Characteristics (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Turn-on time	t _{ON}		See Fig. 12.1.	_	1.2	5	ms
Turn-off time	t _{OFF}		R _L = 200 Ω, V _{DD} = 20 V, I _F = 5 mA	_	0.1	0.5	
Turn-on time	t _{ON}		See Fig. 12.1.	_	0.5	3	
Turn-off time	t _{OFF}		R _L = 200 Ω, V _{DD} = 20 V, I _F = 10 mA	_	0.1	0.5	



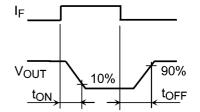
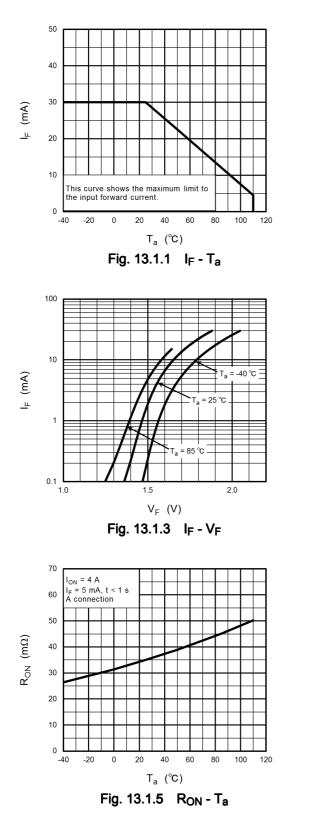
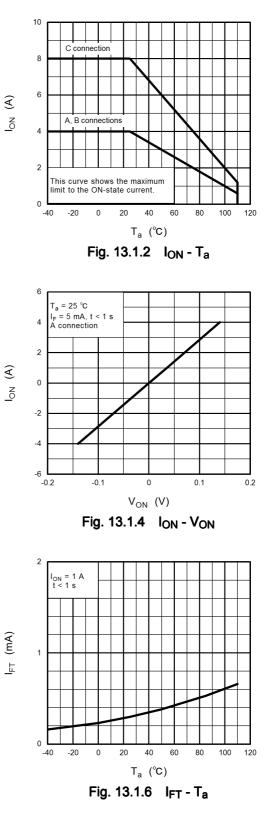


Fig. 12.1 Switching Time Test Circuit and Waveform

13. Characteristics Curves and Circuit Connections

13.1. Characteristics Curves (Note)





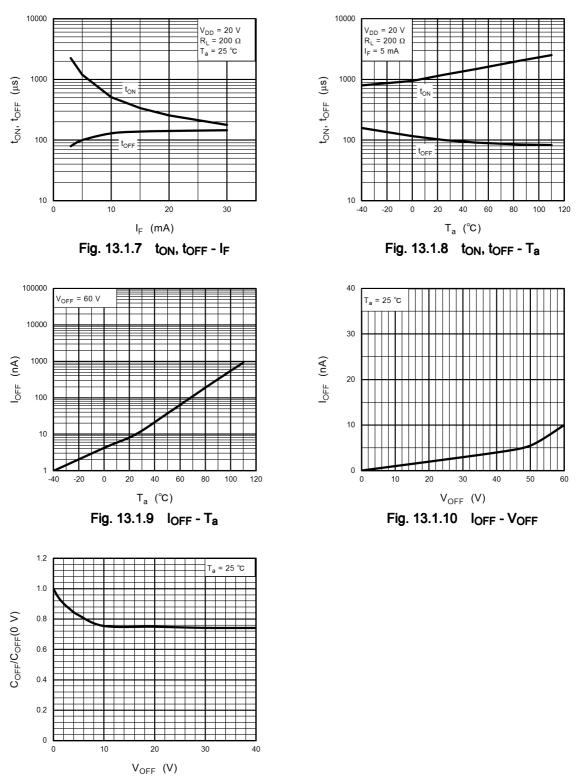


Fig. 13.1.11 COFF/COFF(0 V) - VOFF

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

13.2. Circuit Connections

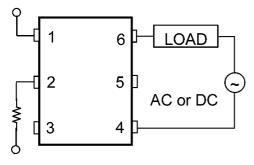


Fig. 13.2.1 A Connection

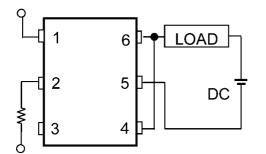
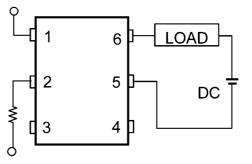
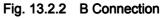


Fig. 13.2.3 C Connection

14. Ordering Information (Example of Item Name)

Item Name	Packaging	VDE Option	Packing (MOQ)
TLP3545A(F(O	тн		Magazine (50 pcs)
TLP3545A(LF1,F(O	LF1		Magazine (50 pcs)
TLP3545A(LF5,F(O	LF5		Magazine (50 pcs)
TLP3545A(TP1,F(O	LF1		Tape and reel (1500 pcs)
TLP3545A(TP5,F(O	LF5		Tape and reel (1500 pcs)
TLP3545A(D4,F(O	ТН	EN60747-5-5	Magazine (50 pcs)
TLP3545A(D4LF1,F(O	LF1	EN60747-5-5	Magazine (50 pcs)
TLP3545A(D4LF5,F(O	LF5	EN60747-5-5	Magazine (50 pcs)
TLP3545A(D4TP1,F(O	LF1	EN60747-5-5	Tape and reel (1500 pcs)
TLP3545A(D4TP5,F(O	LF5	EN60747-5-5	Tape and reel (1500 pcs)
TLP3545AF(F(O	TH, Wide forming		Magazine (50 pcs)
TLP3545AF(LF4,F(O	LF4, Wide forming		Magazine (50 pcs)
TLP3545AF(TP4,F(O	LF4, Wide forming		Tape and reel (1000 pcs)
TLP3545AF(D4,F(O	TH, Wide forming	EN60747-5-5	Magazine (50 pcs)
TLP3545AF(D4LF4F(O	LF4, Wide forming	EN60747-5-5	Magazine (50 pcs)
TLP3545AF(D4TP4F(O	LF4, Wide forming	EN60747-5-5	Tape and reel (1000 pcs)

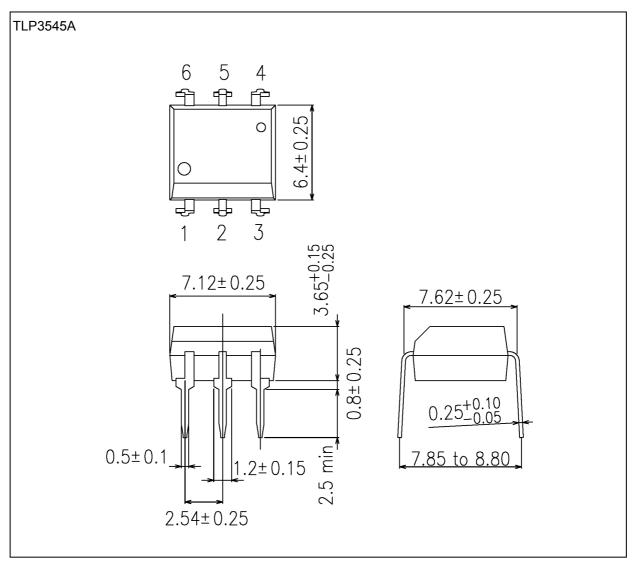




Package Dimensions

TLP3545A,TLP3545AF

Unit: mm



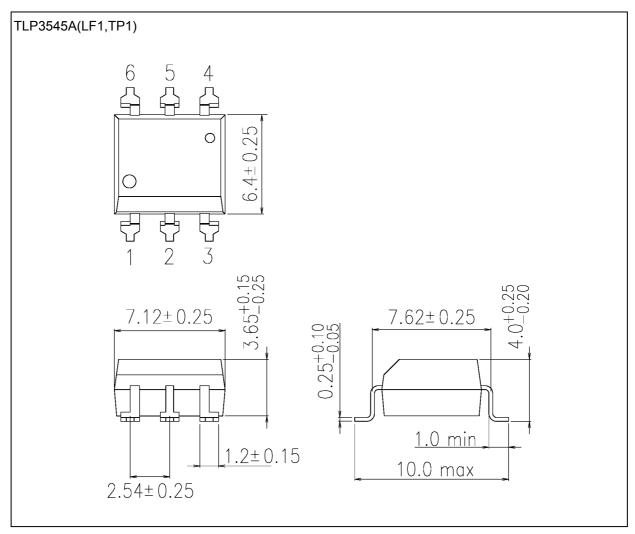
Weight: 0.4 g (typ.)

	Package Name(s)
TOSHIBA: 11-7A8S	



TLP3545A,TLP3545AF

Unit: mm



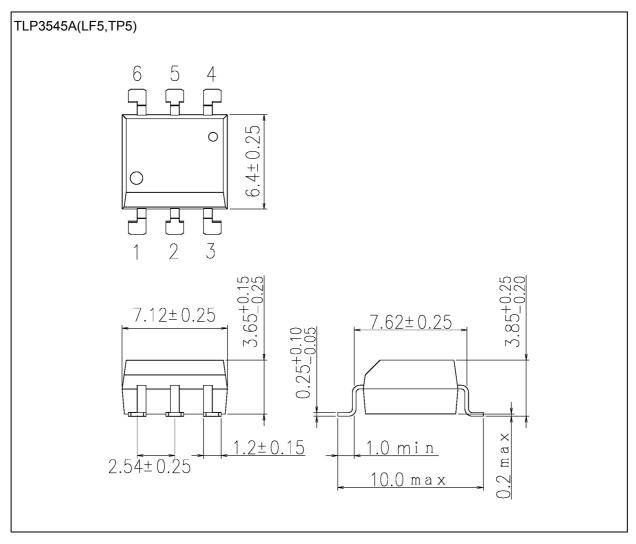
Weight: 0.39 g (typ.)

Package Name(s) TOSHIBA: 11-7A801S



TLP3545A,TLP3545AF

Unit: mm



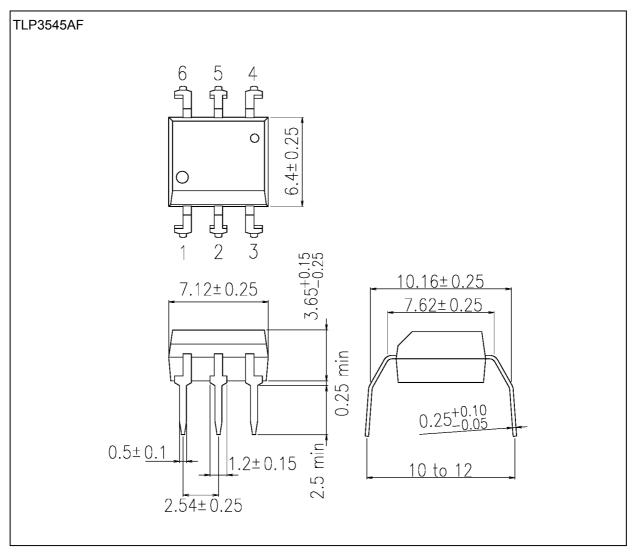
Weight: 0.39 g (typ.)

	Package Name(s)
TOSHIBA: 11-7A805S	



TLP3545A,TLP3545AF

Unit: mm



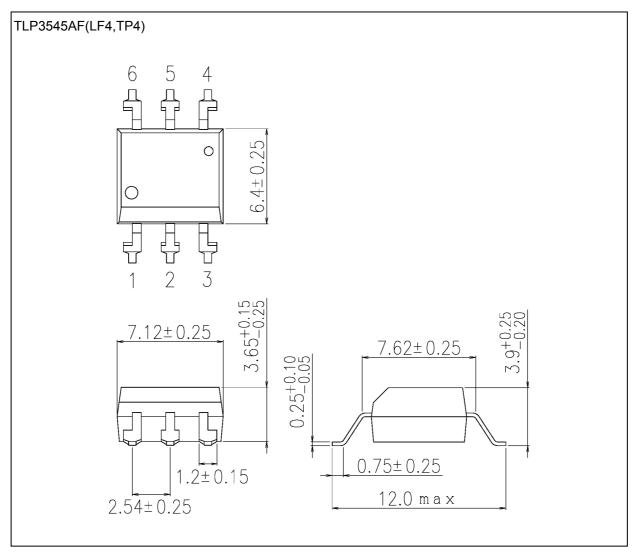
Weight: 0.4 g (typ.)

	Package Name(s)
TOSHIBA: 11-7A802S	



TLP3545A,TLP3545AF

Unit: mm



Weight: 0.39 g (typ.)

	Package Name(s)
TOSHIBA: 11-7A804S	

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